IPC ASSOCIATION CON ELECTRONICS INC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both Is	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mf	g Informatio	on	
upplier In	formation								,					
Company name*			Company unique ID			τ	Unique ID Authority				Response Date*			
nsemi											2024-05-15			
Contact Name	e	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-	-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-Env-	-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	M	Manufacturing Site		Veight*	UOM	Unit Type
	EMI4193M		BMTTAG	ATTAG 3Pair Low Res CMF			2024-05-15 MY1		IY1	1-	4.037421	mg	Each	
Ianufactu	ring Proccess Inform	ation							·					·
			STD-020 MSL I	Rating Peak Process Body Temperature Max Time at Peak					Temperature Number of Reflow Cycles					
Ma	tte Tin (Sn) - annealed	(CU Alloy	1			260		C	30	second	ls 3		
omments														
vel 1 - maxin	num time at peak tempera	ture during sol	ldering is 10-	30 seconds										
or more info	rmation regarding materia	al composition	please refer t	to page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.517421	mg	Supplier	Silicon (Si)	7440-21-3		1.5174	mg
Die Attach Epoxy	0.29	mg		Epoxy resin	proprietary data		0.1885	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.1015	mg
Lead Frame	3.19	mg	Supplier	Zinc (Zn)	7440-66-6		0.0038	mg
			Supplier	Iron (Fe)	7439-89-6		0.075	mg
			Supplier	Copper (Cu)	7440-50-8		3.1103	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	7.7	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.616	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0385	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.154	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.6605	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.231	mg
Plating	0.08	mg	Supplier	Silver (Ag)	7440-22-4		0.0055	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0058	mg
			В	Nickel (Ni)	7440-02-0		0.0679	mg
			Supplier	Gold (Au)	7440-57-5		0.0008	mg
Protection coat	1.14	mg		Polyimide	proprietary data		1.14	mg
Wire Bond - Au	0.12	mg	Supplier	Gold (Au)	7440-57-5		0.12	mg